

## Fujitsu Intel Xeon Gold 6136 processor 3 GHz 24.75 MB L3

**Brand :** Fujitsu **Product code:** S26361-F4051-E236

Product name: Intel Xeon Gold 6136

Intel Xeon Gold 6136, 12C, 3.0GHz, 150W

Fujitsu Intel Xeon Gold 6136. Processor family: Intel® Xeon® Gold, Processor socket: LGA 3647 (Socket P), Processor lithography: 14 nm. Memory channels: Hexa-channel, Maximum internal memory supported by processor: 768 GB, Memory types supported by processor: DDR4-SDRAM. Market segment: Server, Supported instruction sets: AVX, AVX 2.0, AVX-512, SSE4.2, Scalability: S4S. Processor package size: 76.0 x 56.5 mm



Processor		Features	
Processor generation  Processor model *	1st Generation Intel® Xeon® Scalable 6136	PCI Express slots version Supported instruction sets	3.0 AVX, AVX 2.0, AVX-512, SSE4.2
Processor base frequency *	3 GHz	Scalability	S4S
Processor family *	Intel® Xeon® Gold	Embedded options available	×
Processor cores *	12	Processor special features	
Processor socket * Component for	LGA 3647 (Socket P) Server/workstation	Intel® Hyper Threading Technology (Intel® HT Technology)	<b>✓</b>
Processor lithography *	14 nm	Intel® Turbo Boost Technology	2.0
Processor series	Intel Xeon Gold 6000 Series	Intel® AES New Instructions (Intel® AES-NI)	✓
Processor threads Processor operating modes *	24 64-bit	Enhanced Intel SpeedStep Technology	<b>✓</b>
Processor boost frequency	3.7 GHz	Intel Trusted Execution Technology	✓
Processor cache	24.75 MB	Intel® Speed Shift Technology	<b>✓</b>
Processor cache type Thermal Design Power (TDP)	L3 150 W	Intel VT-x with Extended Page Tables (EPT)	✓
Stepping	Н0	Intel TSX-NI	/
Processor codename	Skylake	Intel 64	<b>✓</b>
Memory		Intel Virtualization Technology (VT-	<b>✓</b>
Maximum internal memory supported by processor	768 GB	x) Intel Virtualization Technology for Directed I/O (VT-d)	<b>✓</b>
Memory types supported by processor	DDR4-SDRAM	Conflict-Free processor	1
Memory clock speeds supported by processor	2666 MHz	Intel Turbo Boost Max Technology 3.0	×
Memory channels *	Hexa-channel	Intel® Optane™ Memory Ready	X
ECC	✓	Intel® vPro™ Platform Eligibility	<b>✓</b>
Graphics		Operational conditions	
On-board graphics card *	×	Tcase	85 °C
Discrete graphics card *	×	Weight & dimensions	
On-board graphics card model *	Not available	Processor package size	76.0 x 56.5 mm
Features		Frucessur package size	10.0 X 30.3
Execute Disable Bit	<b>✓</b>		
Market segment	Server		
Maximum number of PCI Express lanes	48		

